## Ceramic

# **Bandpass Filter**

**BFCN-2500+** 

50Ω 2100 to 2900 MHz

## **The Big Deal**

- LTCC construction
- Temperature stable from -55 to +100°C
- Small size (0.126 x .063 X .037")



## **Product Overview**

The BFCN-2500+ LTCC bandpass filter covers the 2100 to 2900 MHz passband with 2 dB passband insertion loss and 20 dB upper/lower stopband rejection. This model handles up to 2.5W RF input power and provides a wide operating temperature range from -55 to +100°C. Utilizing LTCC multi-layer construction, the filter achieves excellent repeatability of performance and comes in a tiny 1206 ceramic package with wraparound terminations, minimizing performance variations due to parasitics and saving space in dense PCB layouts.

# **Key Features**

Feature	Advantages		
LTCC Construction	Provides a rugged package well suited for tough environments such as high humidity and temperature extremes.		
Tiny size (0.126 x .063 x .037")	Saves space in dense circuit boards and minimizes the effects of parasitics.		
Wrap-around terminations	Provides excellent solderability and easy visual inspection		
Wide operating temperature range, -55 to +100°C	Enables reliable performance in extreme environments		

### Ceramic

# **Bandpass Filter**

2100 to 2900 MHz  $50\Omega$ 

#### **Features**

- Good VSWR, 1.8:1 typ. @ passband
- Small size(0.126 x .063 x .037)
- Temperature stable
- LTCC construction

#### **Applications**

- · Harmonic rejection
- Transmitters / Receivers

## **BFCN-2500+**



Generic photo used for illustration purposes only

CASE STYLE: FV1206-4

#### +RoHS Compliant

The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications



Тур.

2500

2

1.8

20

20

20

15

Max.

2.6

Unit

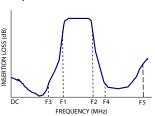
MHz

dB

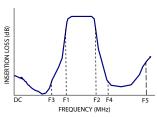
:1

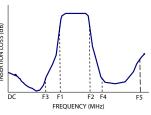
dB

dB



#### **Specification Definition**





Pass Band

Stop Band, Lower

Stop Band, Upper

2. This filter is not intended for use as a DC Blocking circuit element. In Application where DC voltage is present at either input or output ports, blocking capacitors are required at the corresponding RF port.

F1 - F2

F1 - F2

DC - F3

DC - F3

F4 - F5

F4 - F5

Electrical Specifications<sup>1,2</sup> at 25°C

Frequency (MHz)

2100 - 2900

2100 - 2900

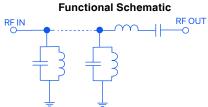
1600

1600

3700 - 5200

3700 - 5200

#### **Maximum Ratings**



Operating Temperature	-55°C to +100°C
Storage Temperature	-55°C to +100°C
RF Power Input*	2.5W at 25°C
	•

**Parameter** 

Center Frequency

Insertion Loss

Insertion Loss

Insertion Loss

**VSWR** 

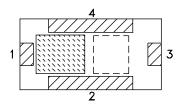
**VSWR** 

**VSWR** 

1. Measured on Mini-Circuits Characterization Test Board TB-824+.

\*Passband rating, derate linearly to 0.7W at 100°C ambient Permanent damage may occur if any of these limits are exceeded.

### **Top View**

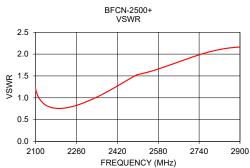


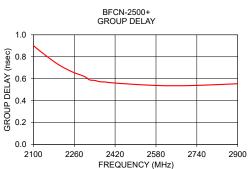
#### BFCN-2500+ INSERTION LOSS (Full Band) <u>용</u> 20 INSERTION LOSS ( 0 1000 2000 3000 4000 5000 6000 FREQUENCY (MHz)





Input	1
Output	3
Ground	2,4





REV. A ECO-011185 ED-17087 BFCN-2500+ AVB/CP/AM 211221 Page 2 of 3

#### **Full Band Performance**

#### **Pass Band Performance**

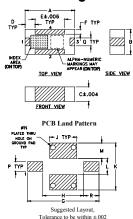
Frequency (MHz)	Insertion Loss (dB)	VSWR (:1)	Frequency (MHz)	Insertion Loss (dB)	Group Delay (nsec)
10	58.18	79.99	2100	1.88	0.90
40	84.01	78.80	2150	1.70	0.81
100	69.04	74.42	2200	1.63	0.73
400	45.88	61.11	2250	1.60	0.66
1000	34.16	43.74	2300	1.60	0.62
1500	33.62	29.10	2320	1.60	0.59
2100	1.88	1.20	2340	1.60	0.58
2500	1.65	1.53	2360	1.61	0.57
2900	2.41	2.16	2380	1.61	0.57
3400	4.69	1.76	2400	1.62	0.56
3800	27.88	14.98	2500	1.65	0.55
4200	39.01	20.59	2600	1.74	0.54
4600	33.90	20.73	2700	1.89	0.54
5000	42.09	11.56	2800	2.11	0.54
5200	28.75	6.04	2900	2.41	0.55

#### **Pad Connections**

Input	1
Output	3
Ground	2,4

#### **Product Marking: GM**

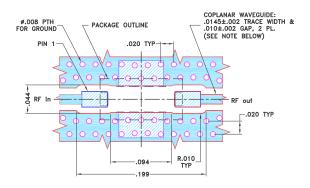
### **Outline Drawing**



#### Outline Dimensions (inch )

.069	.104	.182	.012	.075	D .026 0.66	.037	.063	.126
wt grams .020		.039	.020	.024	N .013 0.33	.039	.041	.119

#### Demo Board MCL P/N: TB-824+ Suggested PCB Layout (PL-454)



- INTEGE WIDTH PARAMETERS ARE SHOWN FOR ROGERS RO4350B WITH DIELECTRIC THICKNESS .0066"±.0007". COPPER: 1/2 OZ. EACH SIDE. FOR OTHER MATERIALS TRACE WIDTH AND GAP MAY NEED TO BE MODIFIED. 2. BOTTOM SIDE OF THE PCB IS CONTIN
- DENOTES PCB COPPER LAYOUT WITH SMOBC (SOLDER MASK OVER BARE COPPER). DENOTES COPPER LAND PATTERN FREE OF SOLDER MASK.

- A. Performance and quality attributes and conditions not expressly stated in this specification document are intended to be excluded and do not form a part of this specification document.
- B. Electrical specifications and performance data contained in this specification document are based on Mini-Circuit's applicable established test performance criteria and measurement instructions.
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